	Туре	L#	Hits	Search Text	DBs	Time Stamp	Co mm en ts	De	Er ro rs
1	BRS	L1	1	or wafer) with (spin\$4 or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/11/25 15:12			

	Type	L #	Hits	Search Text	DBs	Time Stamp	1	De fi	Er
2	BRS	L2	1	or wafer) with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/11/25 15:12			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	Co mm en ts	De	Er
3	BRS	L3	1	mr wateri with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/11/25 15:14			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	mm	Er ro r De fi ni ti	Er ro rs
4	BRS	L4	5	or wafer) with	[. [U() •	2005/11/25 15:21			

	Type	L. #	Hits	Search Text	DBs	Time	Stamp	De fi	Er ro rs
5	BRS	L5	1		USPAT; EPO;	2005/1 15:21	11/25		

	Туре	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
6	BRS	L 6	1	rotat\$4) and (fluid or	TICDATE EDO.	2005/11/25 15:22			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	mm en	Er ro r De fi ni ti	rs
7	BRS	L7	27	rotat\$4) and (fluid or		2005/11/25 15:47			

	Type	L #	Hits	Search Text	DBs	Time Stamp	De	Er ro rs
8	BRS	L8	0	((coat\$6 or spray\$4 or spin adj coat\$4) with (substrate or wafer) and pump with tank and (substrate or wafer) with (spin\$4 or rotat\$4) and (fluid or liquid) with (sens\$4 or detect\$5) and bubble with (releas\$4 or sens\$4 or detect\$4) and valve and pressure).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/11/25 15:48		

	Туре	ъ#	Hits	Search Text	DBs	Time Stamp	Co mm en ts	Dе	Er ro rs
ð	BRS	L9	2	or wafer) with (spin\$4 or rotat\$4) and	1.11261.	2005/11/25 15:49			

	Туре	L #	Hits	Search Text	DBs	Time Stamp		Er ro rs
LO	BRS	L11	13	and (substrate or wafer) with		2005/11/25 15:54		

	Type	L #	Hits	Search Text	DBs	Time Stamp	Co mm en ts	Dе	Er ro rs
11	BRS	L12	14	and (substrate	LIDIA	2005/11/25 15:56			

	Type	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
12	BRS	L17	0	and (substrate		2005/11/25 15:57			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	Co mm en ts	Dе	Er ro rs
13	BRS	L18	0	and (substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/11/25 15:57			
14	BRS	L 10	2	(spin\$4 or	US-PGPUB;	2005/11/25 15:59			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	1	1 1	Er ro rs
15	BRS	L14	1	and (substrate	L D() •	2005/11/25 16:01			

	Type	L #	Hits	Search Text	DBs	Time Stamp	1 1	Er ro rs	
16	BRS	L15	2	and (substrate	US-PGPUB; USPAT; EPO;	2005/11/25 16:01			

		Туре	L #	Hits	Search Text	DBs	Time Sta	mp	Co mm en	De fi	Er ro rs
1	.7	BRS	L 16	1	and (substrate	US-PGPUB; USPAT; EPO;	2005/11/2 16:02	25			

	Туре	L#	Hits	Search Text	DBs	Time Stamp	Co mm en ts	De fi	Er ro rs
18	BRS	L19		and (substrate		2005/11/25 16:02			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	1 1	Er ro rs
L 9	BRS	L20	2	and (substrate	L I D() •	2005/11/25 16:02		

	Type	L #	Hits	Search Text	DBs	Time Stamp	Co mm en ts	Dе	Er ro rs
20	BRS	L21	3	and (substrate	LIDIA	2005/11/25 16:03			

	Type	L#	Hits	Search Text	DBs	Time Stamp	1	De fi	Er ro rs
21	BRS	L22	2	and (substrate	LIDIA	2005/11/25 16:03			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	Co mm en ts	De	Er ro rs
22	BRS	L23	4	and (substrate or wafer) with	LIDIA	2005/11/25 16:04			

	Туре	L#	Hits	Search Text	DBs	Time Stamp	Co mm en ts	Dе	Er
23	BRS	L24	12	and (substrate or wafer) with	I. I Uf 1 •	2005/11/25 16:05			